

L Number	Hits	Search Text	DB	Time stamp
3	21	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor and @ad<=20001120	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/20 07:54
4	14	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor and @ad<=20001120 and copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/20 07:55
-	2	("6329298") or ("4668335")).PN.	USPAT	2003/06/10 11:25
-	581	438/687	USPAT; EPO; JPO; DERWENT	2002/02/14 09:10
-	0	438/687 and (anti-corrosion adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:48
-	0	438/687 and ((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/10/21 13:59
-	0	438/687 and ((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:17
-	2	((corros\$5 adj inhibit\$5) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	16	(anti-corrosion adj treat\$5) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	18	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2003/11/20 07:51
-	186	((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:56
-	223	anti-corrosion adj treat\$5	USPAT; EPO; JPO; DERWENT	2002/08/06 14:53
-	407	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 13:12
-	3	("6329298") or ("4668335") or ("6323131")).PN.	USPAT	2002/02/05 13:43
-	5218	anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/10/21 13:43
-	946	anti-corrosive and copper	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	450808	copper	USPAT; EPO; JPO; DERWENT	2002/10/21 13:57
-	946	copper and anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/02/14 09:28
-	0	(copper and anti-corrosive) and (hetero-cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	2	(copper and anti-corrosive) and (hetero adj cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	0	((copper and anti-corrosive) and (hetero adj cyclic)) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29
-	4	(copper and anti-corrosive) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:24
-	0	((copper and anti-corrosive) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29

-	2175	copper and ((anti-corrosive) or (anti adj corrosion))	USPAT; EPO; JPO; DERWENT	2002/02/14 10:28
-	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 09:30
-	12	(copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	171	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:34
-	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:02
-	52420	copper and ((anticorros\$3) or (corros\$3))	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	163	(copper and ((anticorros\$3) or (corros\$3))) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	20	((copper and ((anticorros\$3) or (corros\$3))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 10:32
-	16	((copper and ((anticorros\$3) or (corros\$3))) and (indazole)) and (interconnect\$3 or wir\$4 or (sheet adj metal))	USPAT; EPO; JPO; DERWENT	2002/02/14 14:37
-	3	("5391257" or ("5641381") or ("5455202")).PN.	USPAT	2002/02/14 14:38
-	172	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39
-	3	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor ) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:38
-	2176	(copper and ((anti-corrosive) or (anti adj corrosion)))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:38
-	3	((copper and ((anti-corrosive) or (anti adj corrosion))) ) and (SiON or (silicon adj oxygen adj nitrogen)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39
-	23	((copper and ((anti-corrosive) or (anti adj corrosion))) ) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39
-	609	(438/687).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:53
-	484110	copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:53
-	836479	copper or ("cu")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:54
-	235539	(copper or ("cu")) and treat\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:56
-	4708	((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:58

	255	((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5)) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:58
	38	((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5)) and semiconductor and (anti-corros\$5 or (anti adj corros\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:59
	1	("6274478").PN.	USPAT	2002/08/06 15:08
	0	((anti-corrosive or (anti adj corrosive)) adj treat\$5) same ((copper-diffus\$4 or (copper adj diffus\$4)) adj (stop\$5 or barrier) adj (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 13:50
	129	(anti-corrosive or (anti adj corrosive)) adj treat\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 14:55
	7	((anti-corrosive or (anti adj corrosive)) adj treat\$5) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 14:01
	483451	copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 13:58
	121	copper and ((anti-corrosion or (anti adj corros\$4) or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/10/21 14:01
	139	copper and ((anti-corrosion or (anti adj corros\$4) or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 14:01
	24	(copper and ((anti-corrosion or (anti adj corros\$4) or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 14:54
	0	(semiconductor adj substrate) same ((anti-corrosive or (anti adj corrosive)) adj treat\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/10/21 14:56
	1	("6350687").PN.	USPAT	2002/10/22 14:23
	0	("jp11003892").PN.	JPO	2002/10/22 13:07
	3	((6350687) or ("5670421") or ("6323131")).PN.	USPAT	2002/10/22 14:24
	57	((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5) and semiconductor	USPAT; EPO; JPO; DERWENT	2003/06/04 09:01
	79	((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/04 10:21
	1	((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5) and ((cu or copper) adj (diffus\$6 adj (barrier or stop\$6))) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/04 10:20
	1	((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5) and ((cu or copper) adj (diffus\$6 adj (barrier or stop\$6)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/04 10:20

-	37	((((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5)) and semiconductor) and (cu or copper)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2003/06/04 10:21
-	55	((((anticorros\$5 or anti-corros\$5 or (anti adj corros\$5)) or (corros\$5 adj inhibit\$5)) adj (treat\$5)) and semiconductor) and (cu or copper)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2003/06/04 10:21
-	4	(("6329298") or ("6099598") or ("4985113") or ("5670421")).PN.	USPAT	2003/06/10 11:38
-	5	((("6329298") or ("6099598") or ("4985113") or ("5670421") or ("6350687")).PN.	USPAT	2003/06/10 15:00
-	1	("20020094602").PN.	US-PGPUB	2003/06/10 15:01